

APPROVAL SHEET

WLPM706630 Series SMD Molded Power Inductor



*Contents in this sheet are subject to change without prior notice.



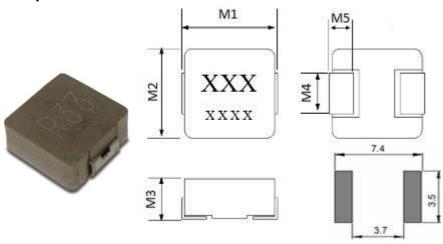
Features

- 1. Shielded construction.
- 2. Ultra low buzz noise.
- 3. Low DCR/µH.
- 4. Handles high transient current spikes without saturation.
- 5. Encapsulated body offers improved environmental protection and moisture resistance.
- 6. Higher dielectric withstanding voltage.
- 7. Corrosion resistant package.
- 8. RoHS Compliance.

Applications

- 1. PDA/Notebook/Desktop/Server applications high current and low profile power supplier
- 2. High current POL converters.
- 3. Battery powered devices.

Shape and Dimension



UNIT: mm								
	DIM.	TOL.						
M1	7.4	max						
M2	6.6	±0.2						
М3	3.0	max						
M4	3.0	±0.3						
М5	1.6	±0.3						

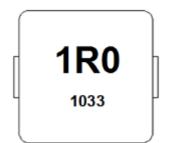
Recommend Pattern

MARKING AND DATE CODE

Marking ex:1.0uH →1R0

Date code

XX XX → year and weekly ex:1033





Ordering Information

WL	PM	7066	30	M	R22	L	С
Product Code	Series	Dimensions	Thickness	Tolerance	Value	Packing Code	
WL: Inductor	SMD Molded power inductor.	7.0 * 6.6mm	2.8mm	M: ± 20%	R22=0.22uH 1R0=1.0uH 100=10uH	L=13" Reeled (Embossed tape)	Internal code

Electrical Characteristics

WLPM706630 series

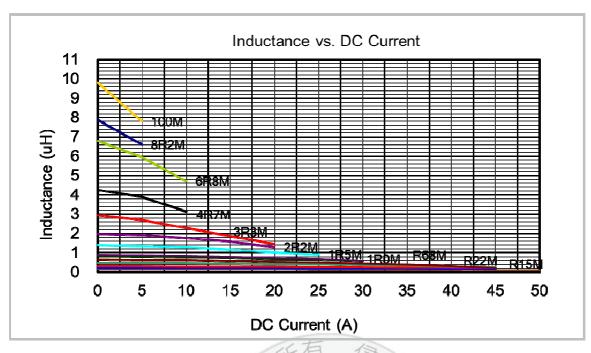
Walsin Part Number	L(uH)	Toleran ce	Test Frequency		DC um (mΩ)	Rated Current	l sat Typical (A)	
				TYP.	MAX.	Typical (A)		
WLPM706630MR15LC	0.15	М	100	2	2.5	27	45	
WLPM706630MR22LC	0.22	М	100	2.5	2.8	23	40	
WLPM706630MR33LC	0.33	M	力100	3.5	3.9	20	30	
WLPM706630MR47LC	0.47	M	100	4	4.2	17.5	26	
WLPM706630MR56LC	0.56	$\langle\langle M_{\perp}\rangle$	100	4.7	5	16.5	25.5	
WLPM706630MR68LC	0.68	M	100	5	5.5	15.5	25	
WLPM706630MR82LC	0.82	##M	100	6.7	8	13	20	
WLPM706630M1R0LC	1.0	М	100 A	9	10	11	20	
WLPM706630M1R5LC	1:53	MASSI	TOO ALLE	ANCE 14	<u>2</u> 15	9	16	
WLPM706630M2R2LC	2.2	M	100	17	20	8	12	
WLPM706630M3R3LC	3.3	M	100	28	30	6	10	
WLPM706630M4R7LC	4.7	Meg	100 C	37	40	5.5	7	
WLPM706630M5R6LC	5.6	MECHA	100 100 ORK	40	44	5.5	6	
WLPM706630M6R8LC	6.8	М	100	54	60	4.5	6.5	
WLPM706630M8R2LC	8.2	М	100	54	60	4.5	6	
WLPM706630M100LC	10	М	100	62	68	4	5.5	

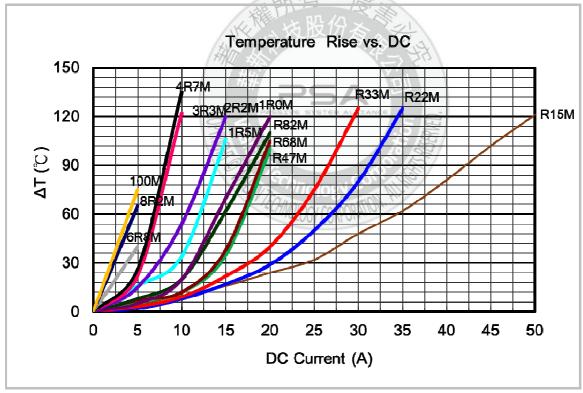
TEST INSTRUMENT: CHROMA 16502 \ Zentech1320+Zentech3305

- (1). Test Freq: 100KHz, 1.0V
- (2). All test data is referenced to 25°C ambient.
- (3). Operating Temperature Range -55 $^{\circ}$ C to +125 $^{\circ}$ C.
- (4). Rated Current: DC current(A)that will cause an approximate △T of 40°C.
- (5). I sat: DC current(A)that will cause Lo to drop approximately 30%.
- (6). The part temperature(ambient +temp rise)should not exceed
 - 125° C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature Part temperature should be verified



Electrical Curve







RELIABILITY PERFORMANCE

Reliability Experiment For Electrical

Test Item	Test Condition	Standard Source		
Humidity Test	$+40^{\circ}\text{C} \pm 2^{\circ}\text{C}$, humidity of 90% \pm 5% (total 96 hours).	MIL-STD-202G Method 103B Test Condition B		
High Temperature Test	1.Temperature: +125°C±2°C 2.Test time: 48±2hrs	IEC 68-2 Test Condition B		
Low Temperature Test	1.Temperature: -40°C±2°C 2.Test time: 48±2hrs	IEC 68-2 Test Condition A		
Thermal Shock	+125°C ±5°C (30 minutes) ~ -40 ± 5°C (30 minutes), temperature switch time: 5 minutes (total 50 cycles).	MIL-STD-202G Method 107G Test Condition B-2		
Life Test	+70°C±5°C (250Hours)	MIL-STD-202G Method 108A Test Condition B		

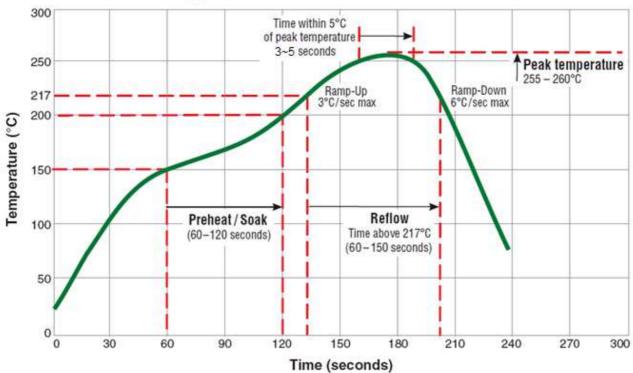
Reliability Experiment For Physical

Test Item	Test Condition	Standard Source
Vibration Test	10-55-10HZ, amplitude: 1.5mm, direction: X, Y, Z axes, each axis 2 hours (total 6 hours).	MIL-STD-202G Method 201A
Solder Heat Resistance Test	IR/convection reflow:Peak Temp 250±5°C for 5Sec in air, Through 2 Cycle. Temperature Ramp:+1~4℃/sec; Above1 83℃, must keep 90 s - 120 s	MIL-STD-202G Method 210F Test Condition (Reflow)
Solder Ability Test	Soak in 245 °C solder pot of 3Sec, PAD must have 95% above coverage.	J-STD-003B



TYPICAL RoHS REFLOW PROFILE

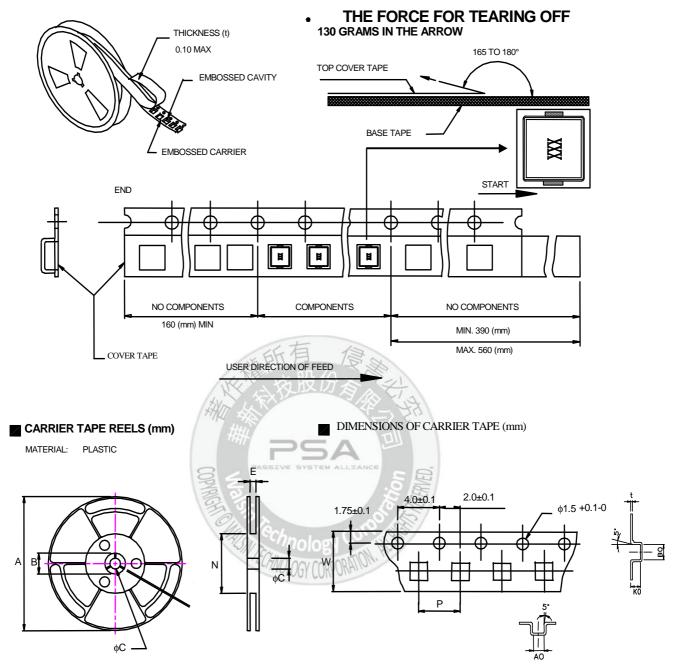
Typical RoHS Reflow Profile







Packaging



¾ 10 sprocket hole pitch cumulative tolerance ±0.20

UNIT: mm

		Α	В	С	E	N	Р	W	t	A0	В0	K0
ſ	DIM.	330	25.0	13.0	16.6	100	12.0	16.0	0.4	6.9	7.6	3.4
Ī	TOL.	±0.2	±0.5	±0.5	±0.5	MIN	±0.1	±0.3	±0.05	±0.1	±0.1	±0.1

Quantity per reel: 1K pcs